MAX20812

Dual-Output, 6A, 3MHz, 2.7V to 16V, Step-Down Switching Regulator

General Description

The MAX20812 is a dual-output, fully integrated, highly efficient, step-down DC-DC switching regulator. This device operates from 2.7V to 16V input supplies, and each output can be regulated from 0.5V to 5.8V. The IC delivers up to 6A of load current per output. The two outputs can be connected in parallel as a single-output, dual-phase regulator that supports up to 12A load current.

The switching frequency of this device can be configured from 500kHz to 3.0MHz and provides the capability of optimizing the design in terms of solution size and performance.

The MAX20812 utilizes fixed-frequency, current-mode control with internal compensation. The dual-switching regulators operate 180° out-of-phase. The MAX20812 features a selectable advanced modulation scheme (AMS) to provide improved dynamic load transient performance. The device also features selectable discontinuous current mode (DCM) operation to improve light load efficiency. Operation settings and configurable features can be selected by connecting pin-strap resistors from the PGM_ pins to ground.

The MAX20812 has an internal 1.8V LDO output to power the gate drives (V_{CC}) and internal circuitry (AVDD). The device also has an optional LDO input pin (LDOIN), allowing connection from a 2.5V to 5.5V bias input supply for optimized efficiency.

The MAX20812 integrates multiple protections including positive and negative overcurrent protection, output overvoltage protection, and overtemperature protection to ensure a robust design.

The MAX20812 is available in a compact 3.5mm x 4.6mm FC2QFN package that supports -40°C to +125°C junction temperature operation.

Applications

- · Communications Equipment
- Networking Equipment
- Servers and Storage Equipment
- Point-of-Load Voltage Regulators
- µP Chipsets
- Memory V_{DDQ}
- I/O Pins of an FPGA/DSP/MCU

Benefits and Features

- High Power Density with Low Component Count
 - Dual-Output or Dual-Phase Operation
 - Single-Supply Operation with Integrated LDO for Bias Generation
 - Optional 2.5V to 5.5V External Bias for Higher Efficiency
 - Compact 3.5mm x 4.6mm, 21-Pin, FC2QFN Package
 - Internal Compensation
- Wide Operating Range
 - 2.7V to 16V Input Voltage Range
 - 0.5V to 5.8V Output Voltage Range
 - 500kHz to 3MHz Configurable Switching Frequency
 - -40°C to +125°C Junction Temperature Range
 - Three Pin-Strap Programming Pins to Select Different Configurations
 - Independent Enable and Power Good for Each Output
- Optimized Performance and Efficiency
 - 92.5% Peak Efficiency with V_{DDH} = 12V,
 V_{OUT} = 1.8V, and f_{SW} = 1MHz
 - Interleaved 180° Out-of-Phase Operation
 - · Selectable AMS to Improve Load Transient
 - Selectable DCM to Improve Light Load Efficiency
 - Active Current Balancing for Dual-Phase Operation

Electrical and Thermal Ratings

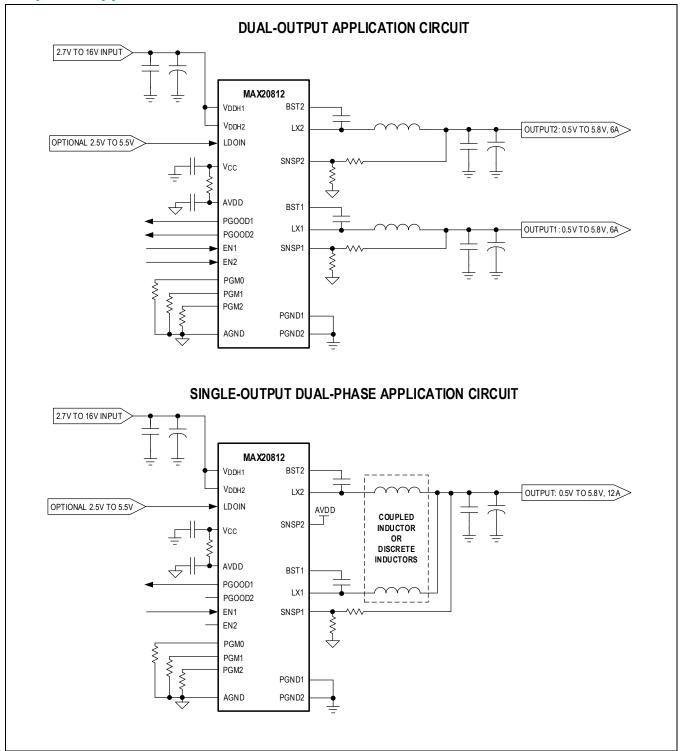
DESCRIPTION	CURRENT RATING* (DUAL- PHASE) (A)	INPUT VOLTAGE (V)	OUTPUT VOLTAGE (V)
Electrical Rating	12	2.7 to 16	0.5 to 5.8
Thermal Rating T _A = +85°C, No Air Flow	12	12	1.8
Thermal Rating T _A = +55°C, 200LFM Air Flow	12	12	5.0

*Maximum $T_J = +125$ °C. For specific operating conditions, see the Safe Operating Area (SOA) curves in the <u>Typical Operating</u> Characteristics.

Ordering Information appears at end of data sheet.



Simplified Application Circuits





Absolute Maximum Ratings

0.3V to +0.3V
0.3V to +2.5V
0.3V to +2.5V
0.3V to +4V
0.3V to +4V
0.3V to AVDD+0.3V
0.3V to +6V
0.3V to AVDD+0.3V
12A to +19A
+150°C
65°C to +150°C
+260°C

Note 1: Input HF capacitors placed not more than 40 mils away from the V_{DDH} pins are required to keep inductive voltage spikes within Absolute Maximum limits.

Note 2: AC is limited to 25ns.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

21 FC2QFN

Ordering Part Number	MAX20812AFH+ (exposed top)	MAX20812TAFH+ (closed top)
Package Code	F213A4F+1	F213A4F+2
Outline Number	21-100394	<u>21-100513</u>
Land Pattern Number	90-100134	90-100184
Thermal Resistance, Four-Layer Board		
Junction to Ambient (θ _{JA}) JEDEC	44.96°C/W	43.9°C/W
Junction to Ambient (θ _{JA}) on MAX20812EVKIT#	20°C/W	20°C/W
Junction to Case (θ_{JC})	0.51°C/W	10.1°C/W

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

(See the <u>Typical Application Circuits</u>. $V_{DDH1} = V_{DDH2} = 12V$, $V_{LDOIN} = 3.3V$, $T_A = T_J = -40^{\circ}C$ to +125°C, unless otherwise noted. Specifications are production tested at $T_A = +32^{\circ}C$; limits within the operating temperature range are guaranteed by design and characterization.)

characterization.)	1	<u> </u>				1	
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
INPUT SUPPLY	1	,					
Input Voltage Range	V_{DDH}		2.7		16	V	
Innut Cunnly Current	L	V _{LDOIN} = 3.3V, EN_ = AGND		0.1		mA	
Input Supply Current	lvddh	V _{LDOIN} = AVDD, EN_ = AGND		2.2		IIIA	
Linear Regulator Input Voltage	V _{LDOIN}		2.5		5.5	V	
Linear Regulator Input	la a a su s	V _{LDOIN} = 3.3V, EN_ = AGND		2.6		™ ∧	
Current	I _{LDOIN}	V _{LDOIN} = 3.3V, EN_ = 1.8V, f _{SW} = 1MHz		22.1		mA	
Internal LDO Regulated Output	V _{CC}		1.71		1.95	V	
		V _{LDOIN} = AVDD	80				
Linear Regulator Current Limit		V _{LDOIN} = 3.3V	100			mA	
Odrient Emili		V _{CC} < 1.6V		20			
AVDD Undervoltage Lockout	AVDD _{UVLO}	Rising	1.65	1.67	1.70	V	
AVDD Undervoltage Lockout Hysteresis				55		mV	
V _{DDH} _ Undervoltage Lockout	V _{DDH_UVLO}	Rising	2.4	2.5	2.6	V	
V _{DDH} _ Undervoltage Lockout Hysteresis				100		mV	
LDOIN Undervoltage Lockout	V _{LDOIN_UVLO}		2.2	2.3	2.4	V	
LDOIN Undervoltage Lockout Hysteresis	V _{LDOIN_UVLO}			100		mV	
OUTPUT VOLTAGE RAN	NGE AND ACCU	RACY					
Internal Reference			0.4945	0.500	0.5055	V	
Voltage		$T_A = T_J = 0$ °C to +85°C	0.497	0.500	0.503	V	
Voltage Sense Leakage Current	I _{SNSP_}	$T_A = T_J = +25^{\circ}C$			1	μΑ	
SWITCHING FREQUENC	CY						
				500			
				750			
Switching Frequency				1000			
	f _{SW} _			1500		kHz	
				2000			
				3000		1	
Switching Frequency Accuracy			-10		+10	%	
Phase Shift Between Two Outputs/Phases		f _{SW1} = f _{SW2}		180		o	

(See the <u>Typical Application Circuits</u>. $V_{DDH1} = V_{DDH2} = 12V$, $V_{LDOIN} = 3.3V$, $T_A = T_J = -40^{\circ}C$ to +125°C, unless otherwise noted. Specifications are production tested at $T_A = +32^{\circ}C$; limits within the operating temperature range are guaranteed by design and characterization.)

PARAMETER	SYMBOL	C	ONDITIONS	MIN	TYP	MAX	UNITS	
Minimum Controllable On-Time		I _{OUT} = 0A	(Note 3)		40	47	ns	
Minimum Controllable Off-Time		I _{OUT} = 0A	(Note 3)		100	110	ns	
ENABLE AND STARTUP	•							
Initialization Time	t _{INIT}				800		μs	
EN The state		Rising		0.9			.,	
EN_ Threshold		Falling				0.6	V	
EN_ Filtering Delay	ten_rising_de LAY	Rising			200			
EN_ Filtering Delay	t _{EN_FALLING_D} ELAY	Falling			2		μs	
Soft-Start Time	t _{SS}				3		ms	
POWER GOOD AND FAI	ULT PROTECTION	NS						
PGOOD_ Output Low	_	I _{PGOOD} = 4mA				0.4	V	
Output Undervoltage (UV) Threshold				-16	-13	-10	%	
Output UV Deglitch Delay					4		μs	
Output Overvoltage Protection (OVP) Threshold				10	13	16	%	
Output OVP Threshold Deglitch Delay					2		μs	
Positive Overcurrent		Inductor peak current, POCP = 9A		7.65 9.00	10.35			
Protection (POCP) Threshold	POCP	Inductor peak co	urrent, POCP = 6A	5.1	6.0	6.9	A	
POCP Deglitch Delay					36		ns	
Fast Positive Overcurrent Protection (FPOCP) Threshold	FPOCP			12.5	14.5	16.5	А	
Negative Overcurrent Protection (NOCP) Threshold to POCP Threshold Ratio	NOCP	With respect to	POCP threshold (typ)		-83		%	
NOCP Accuracy				-20		+20	%	
BST UVLO Threshold	V _{BST}	Rising		1.47	1.57	1.62	\/	
DOT OVEO THIESHOID		Falling		1.41	1.51	1.56	6 V	
Overtemperature Protection (OTP) Rising Threshold	ОТР				155		°C	
OTP Accuracy					6		%	
OTP Hysteresis					20		°C	
Hiccup Protection Time	tHICCUP				20		ms	

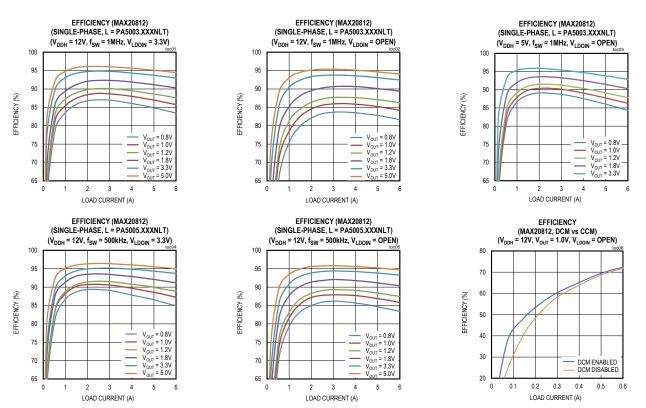
(See the <u>Typical Application Circuits</u>. $V_{DDH1} = V_{DDH2} = 12V$, $V_{LDOIN} = 3.3V$, $T_A = T_J = -40^{\circ}C$ to +125°C, unless otherwise noted. Specifications are production tested at $T_A = +32^{\circ}C$; limits within the operating temperature range are guaranteed by design and characterization.)

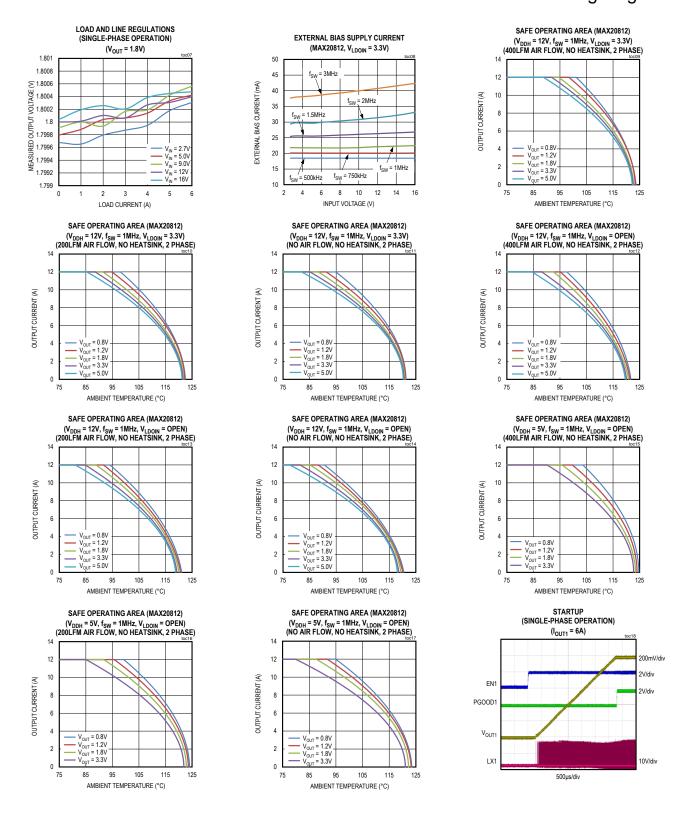
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
DCM OPERATION MODE	DCM OPERATION MODE							
DCM Comparator		POCP = 9A	Inductor valley current	rent -440 uctor valley -310			A	
Threshold to Enter DCM		POCP = 6A	Inductor valley current				- mA	
DCM Comparator Threshold to Exit DCM		Inductor valley current			100		mA	
PROGRAMMING PINS								
PGM_ Pin Resistor Range	R _{PGM} _			0.095		115	kΩ	
PGM_ Resistor Accuracy				-1		+1	%	

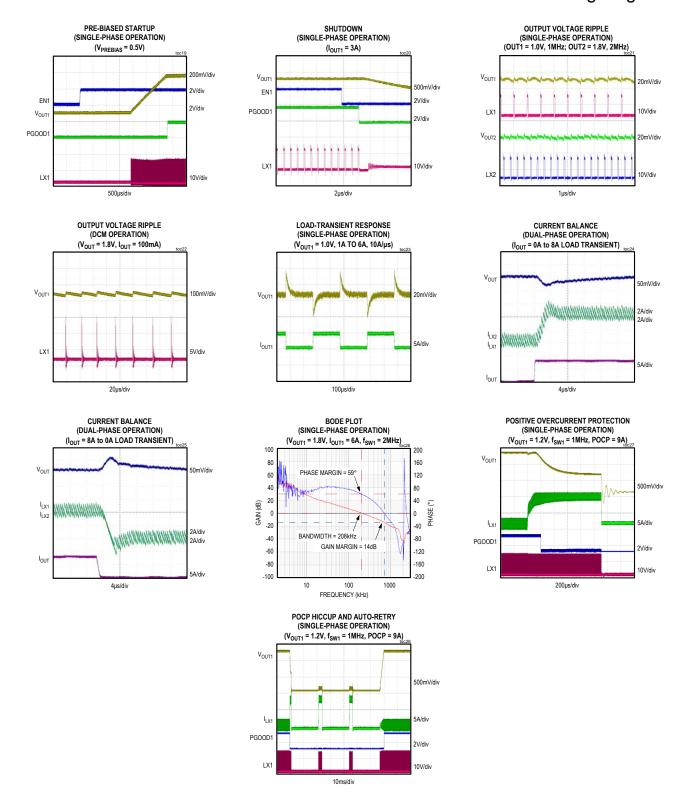
Note 3: Guaranteed by design.

Typical Operating Characteristics

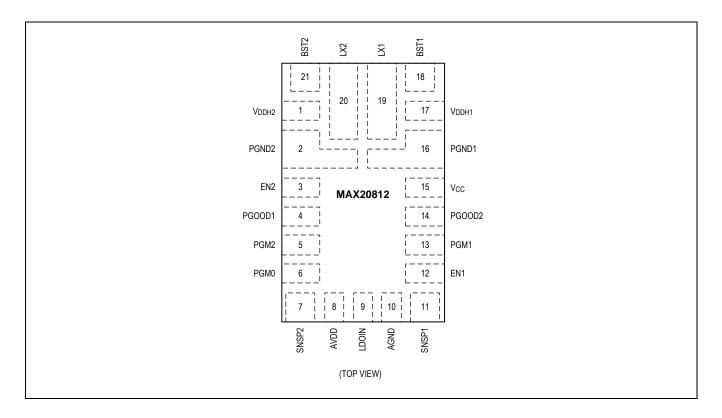
(<u>Typical Application Circuits</u>, V_{DDH} = 12V, tested on MAX20812EVKIT#, T_A = +25°C, unless otherwise noted.)







Pin Configuration



Pin Descriptions

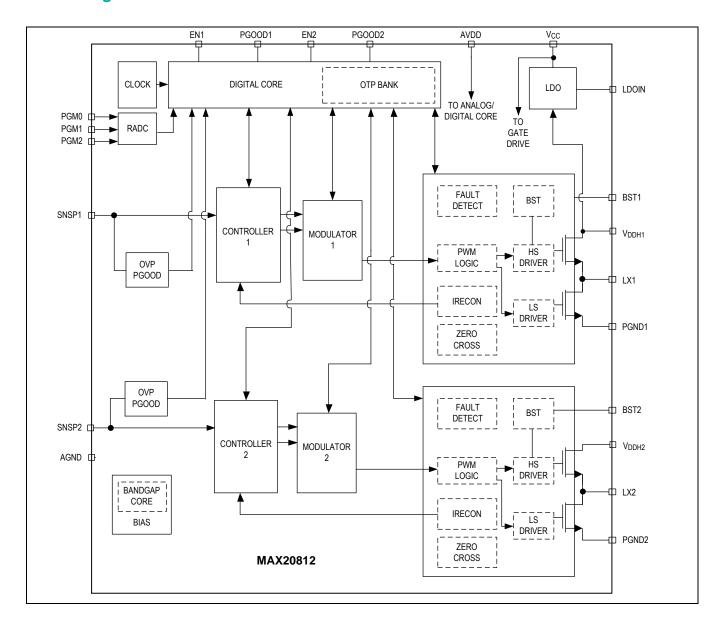
PIN	NAME	FUNCTION
1	V _{DDH2}	Regulator Input Supply for OUTPUT2. V _{DDH1} and V _{DDH2} should be connected on the PCB.
2	PGND2	Power Ground. PGND1 and PGND2 should be connected on the PCB.
3	EN2	Output Enable for OUTPUT2.
4	PGOOD1	Open-Drain Power-Good Output for OUTPUT1.
5	PGM2	Program Input. Connect this pin to ground though a programming resistor.
6	PGM0	Program Input. Connect this pin to ground though a programming resistor.
7	SNSP2	OUTPUT2 Voltage Sense Feedback Pin. Connect SNSP2 to V _{OUT2} at the load. A resistive voltage-divider can be inserted between the output and SNSP2 to regulate the output above the 0.5V fixed reference voltage. Connect SNSP2 to AVDD to select dual-phase operation.
8	AVDD	1.8V Supply for Analog Circuitry. Connect a 2.2Ω to 4.7Ω resistor from AVDD to V_{CC} . Connect a $1\mu F$ or greater ceramic capacitor from AVDD to AGND.
9	LDOIN	Optional 2.5V to 5.5V LDO Input Supply. Connect this pin to AVDD or GND, or leave this pin floating if unused.
10	AGND	Analog Ground.
11	SNSP1	OUTPUT1 Voltage Sense Feedback Pin. Connect SNSP1 to V _{OUT1} at the load. A resistive voltage-divider can be inserted between the output and SNSP1 to regulate the output above the 0.5V fixed reference voltage.
12	EN1	Output Enable for OUTPUT1.

MAX20812

Dual-Output, 6A, 3MHz, 2.7V to 16V, Step-Down Switching Regulator

13	PGM1	Program Input. Connect this pin to ground though a programming resistor.
14	PGOOD2	Open-Drain Power-Good Output for OUTPUT2.
15	V _{CC}	Internal 1.8V LDO Output. Connect a 2.2µF or greater ceramic capacitor from V _{CC} to PGND.
16	PGND1	Power Ground. PGND1 and PGND2 should be connected on the PCB.
17	V _{DDH1}	Regulator Input Supply for OUTPUT1. V _{DDH1} and V _{DDH2} should be connected on the PCB.
18	BST1	Bootstrap Pin for OUTPUT1. Connect a 0.22µF ceramic capacitor from BST1 to LX1.
19	LX1	Switching Node of OUTPUT1. Connect LX1 directly to the output inductor.
20	LX2	Switching Node of OUTPUT2. Connect LX2 directly to the output inductor.
21	BST2	Bootstrap Pin for OUTPUT2. Connect a 0.22µF ceramic capacitor from BST2 to LX2.

Block Diagram



Detailed Description

Dual-Output or Dual-Phase Operation

The MAX20812 by default is configured as a dual-output step-down regulator. This device has two independent control loops for the two outputs, and the loop parameters can be independently selected.

This device can also each be configured as a single output, dual-phase 12A converter by connecting the SNSP2 pin to AVDD. When configured to dual-phase operation, only the control loop for OUTPUT1 will work, and the control loop for OUTPUT2 is bypassed. EN1 and PGOOD1 are used in dual-phase operation mode to enable the device and indicate power-good status. EN2 and PGOOD2 can be disconnected.

Control Architecture

Fixed-Frequency, Peak Current-Mode Control Loop

The MAX20812 control loops are based on fixed-frequency, peak current-mode control architecture. A simplified control architecture is shown in Figure~1. Each loop contains an error amplifier stage, internal voltage loop compensation network, current sense, internal slope compensation, and a PWM modulator that generates the PWM signals to drive high-side and low-side MOSFETs. The device has a fixed 0.5V reference voltage (V_{REF}). The difference of V_{REF} and the sensed output voltage is amplified by the first error amplifier. Its output voltage (V_{ERR}) is used as the input of the voltage loop compensation network. The output of the compensation network (V_{COMP}) is fed to a PWM comparator with the current-sense signal (V_{ISENSE}) and slope compensation (V_{RAMP}). The output of the PWM comparator is the input of the PWM modulator. The turning on of the high-side MOSFET is aligned with an internal clock. It can either be a fixed-frequency clock or a phase-shifted clock if AMS is enabled.

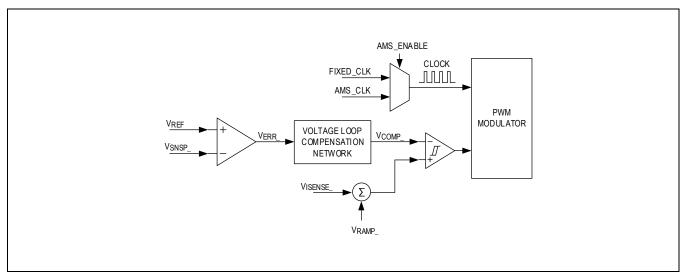


Figure 1. Simplified Control Architecture

Advanced Modulation Scheme (AMS)

The MAX20812 offers a selectable AMS to provide improved dynamic load-transient response. AMS provides a significant advantage over conventional fixed-frequency PWM schemes. Enabling the AMS feature allows for modulation at both leading and trailing edges, which results in a fast switching response during large load transients. *Figure 2* shows the scheme to include leading-edge modulation to the traditional trailing-edge modulation when AMS is enabled in the device. The modulation scheme allows the turn on and off with minimal delay. Since the total inductor current increases very quickly, thus satisfying the load demand, the current drawn from the output capacitors is reduced. With AMS enabled, the system closed-loop bandwidth can be extended without phase-margin penalty. As a result, the output capacitance can be minimized.

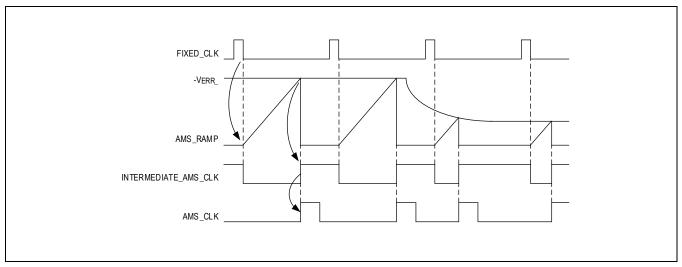


Figure 2. AMS Operation

Discontinuous Current Mode (DCM) Operation

Discontinuous current mode (DCM) operation can be enabled to improve light-load efficiency. V_{DDH} must be at least 2V higher than the desired V_{OUT} for the device to operate in DCM. The device has a DCM current-detection comparator to monitor the inductor valley current while operating in CCM. At light load, if the inductor valley current is below the DCM comparator threshold for 48 consecutive cycles, the device transitions seamlessly to DCM. Once in DCM, the switching frequency decreases as load decreases. The MAX20812 transitions back to CCM operation as soon as the inductor valley current is higher than 100mA.

Active Current Balancing

When configured to dual-phase operation, the MAX20812 operates with active current balancing for enhanced dynamic-current sharing or balancing between two phase currents. This feature maintains the current balance during load transients, even at a load-step frequency close to the switching frequency or its harmonics. The active current-balancing circuit adjusts the individual phase-current control signal in order to minimize the phase-current imbalance.

Internal Linear Regulator

The MAX20812 contains an internal 1.8V linear regulator. The 1.8V voltage on V_{CC} is derived from the V_{DDH1} pin by default. To improve efficiency, it is recommended to apply an external 2.5V to 5.5V bias input supply on the LDOIN pin so that the 1.8V voltage on V_{CC} is converted from the LDOIN pin instead. The LDOIN pin can be connected to the output voltage if the output voltage falls within the 2.5V to 5.5V range. The optional LDOIN bias input supply can be applied or removed anytime during regulation without affecting regulation.

The 1.8V voltage on the V_{CC} pin supplies the current to the MOSFET drivers of both outputs. A decoupling capacitor of at least 2.2 μ F must be connected between V_{CC} and PGND. The AVDD pin of the MAX20812 also requires a 1.8V supply to power the device's internal analog circuitry. A 2.2 Ω to 4.7 Ω resistor must be connected between AVDD and V_{CC} . A 1 μ F or greater decoupling capacitor must be used between AVDD and AGND.

Startup and Shutdown

The startup and shutdown timing is shown in <u>Figure 3</u>. When the AVDD pin voltage is above its rising UVLO threshold, the device goes through an initialization procedure. The dual-output or dual-phase operation is detected. Configuration resistors on the PGM_ pins are read. Once initialization is complete, the device detects the V_{DDH} UVLO and EN_ status. When both are above their rising thresholds, soft-start begins and switching is enabled. The output voltage of the enabled output starts to ramp up. The soft-start ramp time is 3ms. If there are no faults, the open-drain PGOOD_ pin is released from being held low after the soft-start ramp is complete. The device supports smooth startup with the output pre-biased.

During operation, if either V_{DDH} UVLO or EN_ falls below its threshold, switching is stopped immediately. The PGOOD_ pin is driven low. The output voltage is discharged by the load current.

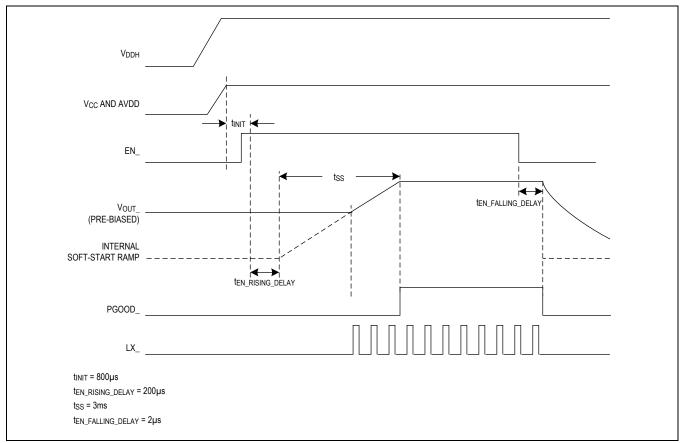


Figure 3. Startup and Shutdown Timing

Fault Handling

Input Undervoltage Lockout (V_{DDH} UVLO)

The MAX20812 internally monitors V_{DDH} with a UVLO circuit. When the input supply voltage is below the UVLO threshold, the device stops switching and drives the PGOOD_ pin low. The device restarts after 20ms hiccup protection time if the V_{DDH} UVLO status is cleared. See the <u>Startup and Shutdown</u> section for the startup sequence.

Output Overvoltage Protection (OVP)

The feedback voltage on SNSP_ is monitored for overvoltage once the soft-start ramp is complete. If the feedback voltage is above the OVP threshold beyond the OVP deglitch filtering delay, the device stops switching and drives the PGOOD_ pin low. The device restarts after 20ms hiccup protection time if the OVP status is cleared. When configured to dual-output operation, the OVP of one output does not affect the operation of the other output.

Positive Overcurrent Protection (POCP)

The device's peak current mode control architecture provides inherent current limiting and short-circuit protection. The inductor current is continuously monitored while switching. The inductor peak current is limited on a cycle-by-cycle basis. In each switching cycle, once the sensed inductor current exceeds the POCP threshold, the device turns off the high-side MOSFET and turns on the low-side MOSFET to allow the inductor current to be discharged by output voltage. An updown counter is used to accumulate the number of consecutive POCP events each switching cycle. If the counter exceeds

1024, the device stops switching and drives the PGOOD_ pin low. The device restarts after 20ms hiccup protection time. When configured to dual-output operation, the POCP of one output does not affect the operation of the other output.

The MAX20812 offers two POCP thresholds (9A and 6A) for each output, which can be selected by the PGM1 and PGM2 pins (see <u>Pin-Strap Programmability</u>). Due to POCP deglitch delay, for a specific application use case, the actual POCP threshold should be higher (see <u>Output Inductor Selection</u>).

Negative Overcurrent Protection (NOCP)

The device also has negative overcurrent protection against inductor valley current. The NOCP threshold is -83% of the POCP threshold. In each switching cycle, once the sensed inductor current exceeds the NOCP threshold, the device turns off the low-side MOSFET and turns on the high-side MOSFET for a fixed 180ns time to allow the inductor current to be charged by input voltage. Same as the POCP, an up-down counter is used to accumulate the number of consecutive NOCP events. If the counter exceeds 1024, the device stops switching and drives the PGOOD_ pin low. The device restarts after 20ms hiccup protection time. When configured to dual-output operation, the NOCP of one output does not affect the operation of the other output.

Overtemperature Protection (OTP)

The overtemperature protection threshold is +155°C with 20°C hysteresis. If the junction temperature reaches the OTP threshold during operation, the device stops switching and drives the PGOOD_ pin low. The device restarts if the OTP status is cleared.

Pin-Strap Programmability

The MAX20812 has three program pins (PGM0, PGM1, and PGM2) to set some of the key configurations of the device. A pin-strap resistor is connected from the PGM_ pin to AGND, and its value is read during startup initialization. PGM0 selects the common settings that apply to both outputs (AMS and switching frequencies). When the device is configured to dual-output operation, PGM1 selects the POCP and internal compensation parameters of OUTPUT1; PGM2 selects the POCP and internal compensation parameters of OUTPUT2. When the device is configured to dual-phase operation, the POCP and internal compensation parameters are selected only by PGM1. See the Internal Compensation Selection section for information about how to select the compensation parameters for optimized control loop performance.

Table 1. PGM0 Switching Frequency, AMS, and DCM Selections

PGM0 CODES	R (Ω)	AMS	DCM	fsw1 (kHz)	f _{SW2} (kHz)									
0	95.3			500	500									
1	200			500	1000									
2	309			750	750									
3	422			750	1500									
4	536			1000	500									
5	649	Disable		1000	1000									
6	768	Disable		1000	2000									
7	909					1500	750							
8	1050			1500	1500									
9	1210	Disab		Disable	2000	1000								
10	1400												Disable	2000
11	1620			3000	3000									
12	1870			500	500									
13	2150			500	1000									
14	2490			750	750									
15	2870	Enable		750	1500									
16	3740			1000	500									
17	8060			1000	1000									
18	12400			1000	2000									
19	16900			1500	750									

20	21500		1500	1500
21	26100		2000	1000
22	30900		2000	2000
23	36500		3000	3000
24	42200		500	500
25	48700		500	1000
26	56200		750	750
27	64900	Enable	1000	500
28	75000	Enable	1000	1000
29	86600		1500	1500
30	100000		2000	2000
31	115000		3000	3000

Table 2. PGM1 Configurations for OUTPUT1 or Dual-Phase Operation

PGM1 CODES	R (Ω)	POCP1 (A)	VOLTAGE LOOP GAIN MULTIPLIER 1	SLOPE1 (µA)
0	95.3			1.5
1	200			2.6
2	309		0.4	3.7
3	422		0.4	6.0
4	536			7.0
5	649			8.0
6	768			1.5
7	909			2.6
8	1050		0.7	3.7
9	1210		0.7	6.0
10	1400			7.0
11	1620	9		8.0
12	1870			1.5
13	2150			2.6
14	2490		1	3.7
15	2870		ı	6.0
16	3740			7.0
17	8060			8.0
18	12400			1.5
19	16900			2.6
20	21500		1.5	3.7
21	26100			6.0
22	30900			7.0
23	36500			1.5
24	42200		0.4	2.6
25	48700			7.0
26	56200			1.5
27	64900	6	0.7	2.6
28	75000			7.0
29	86600			1.5
30	100000		1	2.6
31	115000			7.0

			115 101 001 P012	
PGM2	R	POCP2	VOLTAGE LOOP GAIN	SLOPE2
CODES	(Ω)	(A)	MULTIPLIER 2	(μΑ)
0	95.3			1.5
1	200			2.6
2	309		0.4	3.7
3	422		0.4	6.0
4	536			7.0
5	649			8.0
6	768			1.5
7	909			2.6
8	1050		0.7	3.7
9	1210		0.7	6.0
10	1400			7.0
11	1620	9		8.0
12	1870			1.5
13	2150			2.6
14	2490		4	3.7
15	2870		1	6.0
16	3740			7.0
17	8060			8.0
18	12400			1.5
19	16900			2.6
20	21500		1.5	3.7
21	26100			6.0
22	30900			7.0
23	36500			1.5
24	42200		0.4	2.6
25	48700			7.0
26	56200			1.5
27	64900	6	0.7	2.6
28	75000			7.0
29	86600			1.5
30	100000		1	2.6
31	115000			7.0

Reference Design Procedure

Output Voltage Sensing

The MAX20812 has an internal 0.5V reference voltage. When the desired output voltage is higher than 0.5V, it is required to use resistor-dividers R_{FB1} and R_{FB2} to sense the output voltage (see the <u>Typical Application Circuits</u>). It is recommended that the value R_{FB2} does not exceed $5k\Omega$. The resistor-divider ratio is given by the following equation:

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R_{FB1}}{R_{FB2}}\right)$$

where:

V_{OUT} = Output voltage

V_{REF} = 0.5V fixed reference voltage

R_{FB1} = Top resistor-divider

RFB2 = Bottom resistor-divider

Switching Frequency Selection

The MAX20812 offers a wide range of selectable switching frequencies from 500kHz to 3MHz. Switching frequency selection can be optimized for different applications. Higher switching frequencies are recommended for applications prioritizing solution size so that the value and size of output LC filter can be reduced. Lower switching frequencies are recommended for applications prioritizing efficiency and thermal dissipation due to reduced switching losses. The frequency must be selected so that the minimum controllable on-time and minimum controllable off-time are not violated. The maximum recommended switching frequency is calculated by the following equation:

$$f_{SWMAX} = MIN \left\{ \frac{V_{OUT}}{t_{ONMIN} \times V_{DDHMAX}}, \frac{V_{DDHMIN} - V_{OUT}}{t_{OFFMIN} \times V_{DDHMIN}} \right\}$$

where:

f_{SWMAX} = Maximum selectable switching frequency

V_{DDHMAX} = Maximum input voltage

V_{DDHMIN} = Minimum input voltage

tonmin = Minimum controllable on-time

tOFFMIN = Minimum controllable off-time

Due to system noise injection, even at steady-state operation, typically the LX rising and falling edges would have some random jittering noise. The selection of the switching frequency (f_{SW}) should take into consideration the jittering and be lower than f_{SWMAX}. To improve the LX jittering, it is recommended to use smaller inductor values and lower voltage loop gain to minimize the noise sensitivity.

Output Inductor Selection

The output inductor has an important influence on the overall size, cost, and efficiency of the voltage regulator. Since the inductor is typically one of the larger components in the system, a minimum inductor value is particularly important in space-constrained applications. Smaller inductor values also permit faster transient response, reducing the amount of output capacitance needed to maintain transient tolerance.

To improve current loop noise immunity, typically the output inductor is selected so that the inductor current ripple is at least 1A. The inductor value is calculated by the following equation:

$$L = \frac{V_{OUT}(V_{DDH} - V_{OUT})}{V_{DDH} \times I_{RIPPLE} \times f_{SW}}$$

where:

V_{DDH} = Input voltage

IRIPPI F = Inductor current ripple peak-to-peak value

The inductor should also be selected so that maximum load current delivery can be guaranteed by the selected POCP threshold. The MAX20812 offers two POCP thresholds (9A and 6A) for each output, which can be selected by the PGM1 and PGM2 pins (see *Pin-Strap Programmability*). Due to deglitch delay from the POCP comparator tripping to the high-side MOSFET turning off for a specific application use case, the adjusted POCP threshold should take into consideration the inductor value, input voltage, and output voltage, which can be calculated by the following equation:

$$POCP_{ADJUST} = POCP + \frac{(V_{DDH} - V_{OUT}) \times t_{POCP}}{L}$$

where:

POCP_{ADJUST} = Adjusted POCP threshold

POCP = POCP level specified in the <u>Electrical Characteristics</u> table

t_{POCP} = POCP deglitch delay (36ns, typ)

It needs to be verified that the peak inductor current in normal operation does not exceed the minimum adjusted POCP threshold:

$$\frac{I_{OUTMAX}}{N} + \frac{I_{RIPPLE}}{2} < POCP_{ADJUST(MIN)}$$

where:

N = Number of phases

I_{OUTMAX} = Maximum load current

POCP_{ADJUST(MIN)} = Minimum adjusted POCP threshold, calculated with the minimum value of the POCP threshold

<u>Table 4</u> shows some suitable inductor part numbers which are verified on the MAX20812 evaluation (EV) kit to offer optimal performance.

Table 4. Recommended Inductors

COMPANY	VALUE (µH)	I _{SAT} (A)	R _{DC} (mΩ)	FOOTPRINT (mm)	HEIGHT (mm)	PART NUMBER
TDK	0.22	9	8	2.5 × 2.0	1.2	TFM252012ALMAR22MTAA
TDK	0.33	8.4	10	3.2 × 2.5	1.2	TFM322512ALMAR33MTAA
Pulse	0.47	26	3.75	5.5 × 5.3	2.9	PA5003.471NLT
Pulse	0.56	22.2	4.05	5.5 × 5.3	2.9	PA5003.561NLT
Pulse	1.0	16.5	6.9	5.5 × 5.3	2.9	PA5003.102NLT
Pulse	2.2	10	13.2	5.5 × 5.3	2.9	PA5003.222NLT

Output Capacitor Selection

One major factor in determining the total required output capacitance is the output-voltage ripple. To meet the output-voltage ripple requirement, the minimum output capacitance should satisfy the following equation:

$$C_{OUT} \ge \frac{I_{RIPPLE}}{8 \times N \times f_{SW} \times (V_{OUTRIPPLE} - ESR \times I_{RIPPLE})}$$

where:

VOUTRIPPLE = Maximum allowed output-voltage ripple

ESR = ESR of output capacitors

The other important factors in determining the total required output capacitance are the maximum allowable output voltage overshoot and undershoot during load transients. For a given loading or unloading current step, the minimum required output capacitance can be estimated by the following equation:

$$C_{OUT} \geq \text{MAX} \left\{ \frac{\left(\frac{\Delta I}{N} + \frac{I_{RIPPLE}}{2}\right)^2 \times L \times N}{2 \times \Delta V_{OUT} \times \left(V_{DDH} - V_{OUT}\right)}, \frac{\left(\frac{\Delta I}{N} + \frac{I_{RIPPLE}}{2}\right)^2 \times L \times N}{2 \times \Delta V_{OUT} \times V_{OUT}} \right\}$$

where:

C_{OUT} = Output capacitance

△I = Loading or unloading current step

△VOLIT = Maximum allowed output voltage undershoot or overshoot

Input Capacitor Selection

The input capacitance selection is determined by the input voltage ripple requirement. The V_{DDH1} and V_{DDH2} pins of the MAX20812 should be connected on the PCB. When configured to dual-output operation, the input capacitance is shared between the two outputs. The minimum required input capacitance is estimated by the following equation:

$$C_{IN} \geq MAX \left\{ \frac{I_{OUT1(MAX)} \times V_{OUT1}}{f_{SW1} \times V_{DDH} \times V_{INPP}}, \frac{I_{OUT2(MAX)} \times V_{OUT2}}{f_{SW2} \times V_{DDH} \times V_{INPP}} \right\}$$

where:

C_{IN} = Input capacitance

I_{OUT} (MAX) = Maximum output current of OUTPUT_

V_{OUT} = Output voltage of OUTPUT_

f_{SW} = Switching frequency of OUTPUT_

V_{INPP} = Peak-to-peak input voltage ripple

When configured to dual-phase operation, the minimum required input capacitance is estimated by the following equation:

$$C_{IN} \ge \frac{I_{OUT(MAX)} \times V_{OUT}}{2 \times f_{SW} \times V_{DDH} \times V_{INPP}}$$

Besides the minimum required input capacitance, it is also required to place $0.1\mu\text{F}$ and $1\mu\text{F}$ high-frequency decoupling capacitors next to each V_{DDH} pin to suppress the high-frequency switching noises.

Internal Compensation Selection

Voltage Loop Gain

For stability purposes, it is recommended that the voltage loop bandwidth (BW) be lower than 1/5 of the switching frequency. Consider the case of using MLCC output capacitors that have nearly ideal impedance characteristics in the frequency range of interest with negligible ESR and ESL. The voltage loop BW can be estimated using the following equation:

$$BW = \frac{N \times \frac{R_{FB2}}{R_{FB2} + R_{FB1}} \times \frac{R_{VGA}}{10k\Omega}}{2\pi \times 20m\Omega \times C_{OUT}}$$

where:

 R_{VGA} = The voltage loop gain resistance, which is set by the switching frequency and voltage loop gain multiplier selected by PGM_ pin resistors (<u>Table 5</u>)

Table 5. Voltage Loop Gain Resistance

rabio or ronago	Loop cam	· toolotailoo
SWITCHING FREQUENCY (kHz)	VOLTAGE LOOP GAIN MULTIPLIER	R _{VGA} (kΩ)
	0.4	15.6
500	0.7	27
	1	37

	1.5	52.2
	0.4	22
750	0.7	31
750	1	44.5
	1.5	62.3
	0.4	22
1000	0.7	37
1000	1	52.2
	1.5	74.5
	0.4	27
1500	0.7	44.5
1500	1	62.3
	1.5	104.4
	0.4	31
2000 or 3000	0.7	52.2
2000 01 3000	1	74.5
	1.5	104.4

Slope Compensation

Slope compensation is applied to guarantee current loop stability when the duty cycle is higher than 50%. For applications where the duty cycle is smaller than 50%, it is also recommended to apply slope compensation to improve current loop noise immunity. The minimum and maximum slope compensation values are calculated using the following equation:

$$\frac{V_{OUT}}{L} \times C_{SLOPE} \times \frac{1.6\Omega}{25} \leq SLOPE \leq \frac{V_{IN} \times f_{SW} \times C_{SLOPE}}{V_{OUT}} \left[800 \text{mV} - \left(\frac{I_{OUTMAX}}{N} + \frac{I_{RIPPLE}}{2} \right) \times \frac{1.6\Omega}{25} \right]$$

where:

CSLOPF = 5pF

The slope-compensation options of the MAX20812 can be selected by resistor values on PGM1 and PGM2. A higher slope value is recommended to help reduce duty cycle jittering and improve stability.

Typical Reference Designs

See the <u>Typical Application Circuits</u> for examples of reference schematics. Reference design examples for some common output voltages are shown in *Table 6*.

Table 6. Reference Design Examples

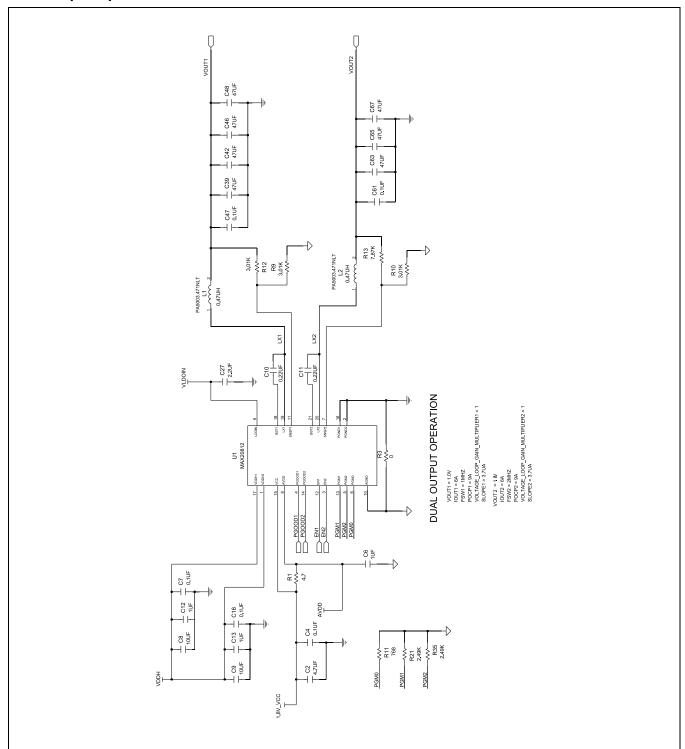
V _{OUT} (V)	I _{OUT} (A) (PER PHASE)	f _{SW} (kHz)	R _{FB1} (kΩ)	R _{FB2} (kΩ)	PGM0 (kΩ)	PGM1 OR PGM2 (kΩ)	L (µH)	C _{IN} (PER EACH V _{DDH} PIN)	C _{OUT}
0.8	6	750	1.82	3.01	2.49	2.49	0.47	10μF +1μF +0.1μF	$3 \times 47 \mu F$
0.9	6	1000	2.40	3.01	8.06	2.49	0.47	10μF +1μF +0.1μF	3 × 47µF
1.0	6	1000	3.01	3.01	8.06	2.49	0.47	10μF +1μF +0.1μF	3 × 47µF
1.2	6	1000	4.22	3.01	8.06	2.49	0.56	10μF +1μF +0.1μF	3 × 47µF
1.8	6	1500	7.87	3.01	21.5	2.49	0.56	10μF +1μF +0.1μF	2 × 47µF
3.3	5	2000	16.9	3.01	30.9	2.15	1.0	10μF +1μF +0.1μF	2 × 47µF
5.0	4	2000	22.6	2.49	30.9	100	2.2	10μF +1μF +0.1μF	1 × 47µF

PCB Layout Guidelines

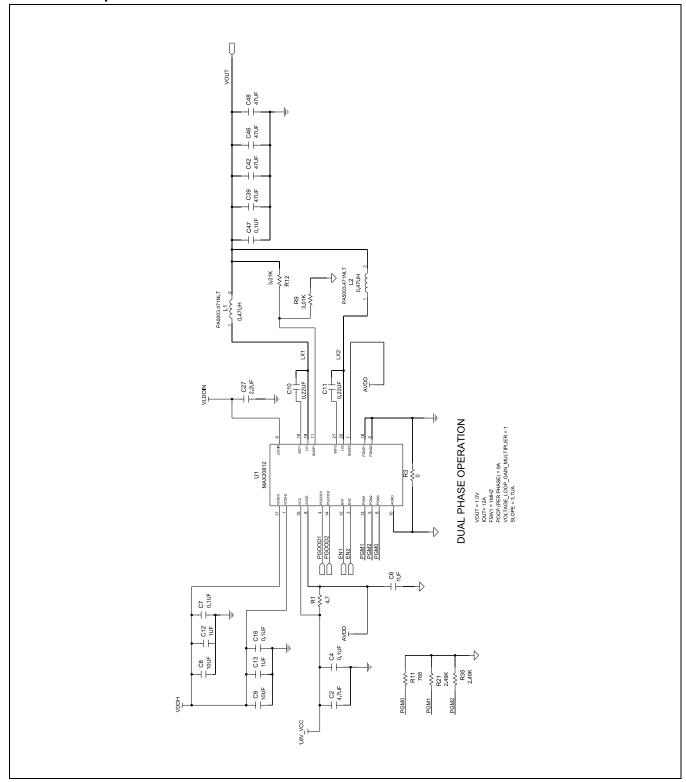
- For electrical and thermal reasons, the second layer from the top and bottom of the PCB should be reserved for power ground (PGND) planes.
- The input decoupling capacitor should be located the closest to the IC and no more than 40 mils from the V_{DDH} pins.
- The V_{CC} decoupling capacitors should be connected to PGND and placed as close as possible to V_{CC} pin.
- An analog ground copper polygon or island should be used to connect all analog control-signal grounds. This "quiet" analog ground copper polygon or island should be connected to the PGND through a single connection close to the AGND pin. The analog ground can be used as a shield and ground reference for the control signals (PGM_ and SNSP_).
- The AVDD decoupling capacitors should be connected to AGND and placed as close as possible to AVDD pin.
- The boost capacitors should be placed as close as possible to LX_ and BST_ pins on the same side of the PCB as the IC.
- The feedback resistor-divider and optional external compensation network should be placed close to the IC to minimize the noise injection.
- The voltage sense line should be shielded by ground plane and be kept away from switching node and the inductor.
- Multiple vias are recommended for all paths that carry high currents and for heat dissipation.
- The input capacitors and output inductors should be placed near the IC and the traces to the components should be kept as short and wide as possible to minimize parasitic inductance and resistance.

Typical Application Circuits

Dual-Output Operation



Dual-Phase Operation



Ordering Information

PART NUMBER	TEMPERATURE RANGE	PIN-PACKAGE
MAX20812AFH+	-40°C to +125°C	21 FC2QFN (exposed top)
MAX20812AFH+T	-40°C to +125°C	21 FC2QFN (exposed top)
MAX20812TAFH+*	-40°C to +125°C	21 FC2QFN (closed top)
MAX20812TAFH+T*	-40°C to +125°C	21 FC2QFN (closed top)

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

^{*}Future product—contact factory for availability.

MAX20812

Dual-Output, 6A, 3MHz, 2.7V to 16V, Step-Down Switching Regulator

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/20	Initial release	_
1	3/21	Updated General Description, Benefits and Features, Electrical and Thermal Ratings, Absolute Maximum Ratings, Package Information, Electrical Characteristics table, Typical Operating Characteristics, Pin Configurations, Pin Descriptions, Block Diagrams, Detailed Description, Applications Information, Typical Application Circuits, Ordering Information table	1, 3–9, 11, 13, 15–16, 18–25

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.